Q7-BT

Qseven[®] Standard Size Module with Intel[®] Atom™ Processor E3800 Series System-on-Chip

Features

- Single, dual or quad-core Intel[®] Atom[™] Processor E3800 Series
 System-on-Chip
- Up to 4 GB DDR3L at 1066/1333 MHz
- HDMI 1.4b and dual channel LVDS
- GbE, MIPI CSI camera interface
- 2x SATA 3Gb/s or 1x SATA and 1x SATA-SSD
- Extreme Rugged™ -40°C to +85°C or commercial temp. 0°C to +60°C
- Supports Smart Embedded Management Agent (SEMA) functions 2.5 or 3.0



Specifications

Core System

| CPU | Intel® Atom™ Processor E3800 Series, single, |
|---------------|--|
| | dual or quad-core SoC with integrated graphics |
| | E3845 (4C/1333), 1.91 GHz, Gfx 542/792 MHz |
| | (Turbo), 10 W TDP |
| | E3826 (2C/1066), 1.46 GHz, Gfx 533/667 MHz |
| | (Turbo), 7 W TDP |
| | E3815 (1C/1066), 1.46 GHz, Gfx 400 MHz |
| | (no Turbo), 5 W TDP |
| | E3805 (2C/1066), 1.33 GHz (No GFX) 3W TDP |
| | Other processors on request |
| Memory | Up to 4 GB DDR3L at 1066/1333 MHz |
| Embedded BIOS | AMI UEFI with CMOS backup in 8 MB SPI BIOS, |
| | Fast Boot support |
| Cache | 512 kB to 2 MB L2 cache |
| SEMA® Board | Supports: Voltage/Current monitoring, Logistics |
| Controller | and Forensic information, Flat Panel Control, |
| | I2C Bus Control, User Flash, Failsafe BIOS (dual |
| | BIOS), Watchdog Timer and Fan Control |

Video

| GPU Feature Support | 7th generation Intel® graphics core architectur with four execution units supporting two independent displays |
|---------------------|---|
| | 2D and 3D graphics hardware acceleration |
| | Support for DirectX 11.1, OGLES 2.0, OGL 3.2 |
| | Video decode HW acceleration for H.264, |
| | MPEG2, VC1, VP8 formats Video encode HW |
| | acceleration for H.264, MPEG2 formats |
| LVDS | Dual channel 18/24-bit LVDS from DDI0 |
| HDMI | HDMI from DDI1 (up to 2,560 x 1,600 pixels) |

Audio

| Chipset | Intel [®] HD Audio controller integrated in SOC |
|----------|--|
| Ports | HDA for audio codec on carrier |
| Ethernet | |

Intel® MAC/PHY 1x Intel® i210IT Ethernet controller Interface 10/100/1000 GbE

I/O Interfaces

| PCle | 3x PCle x1 Gen2 |
|--------|--|
| USB | 1x USB 3.0 + 5x USB 2.0 host + 1x USB 2.0 client |
| SATA | 2x SATA 3 Gb/s or 1x SATA & 1x SATA-SSD |
| | (optional) |
| eMMC | Soldered, bootable eMMC flash storage from |
| | 4GB to 64GB (optional) |
| SSD | onboard SATA-SSD (optional) |
| SDIO | 1x SDIO (4-bit) |
| Camera | CSI 4L/1L on feature connector |
| Serial | 1x I ² C, 1x SPI, 1x HS-UART, Power Management, |
| | SMBus |
| LPC | 1x LPC |

Power

| Standard Input | 5.0 V ±5% |
|----------------|--------------------------------|
| Power States | Supports C0-C6, S0, S3, S4, S5 |

Operation System

| Standard Support | Linux, VxWorks, Windows 7/8, |
|------------------|------------------------------|
| | Windows Embedded, Compact 7 |
| On Request | QNX, Android |

Mechanical and Environmental

| Form Factor | Qseven Specification 2.0 |
|-------------|------------------------------|
| Dimension | Standard size, 70 mm x 70 mm |

Operating Temperature Standard: 0°C to +60°C

Extreme Rugged: -40°C to +85°C

Humidity 5-90% RH operating, non-condensing

5-95% RH storage

(and operating with conformal coating)

Shock and Vibration IEC 60068-2-64 and IEC-60068-2-27

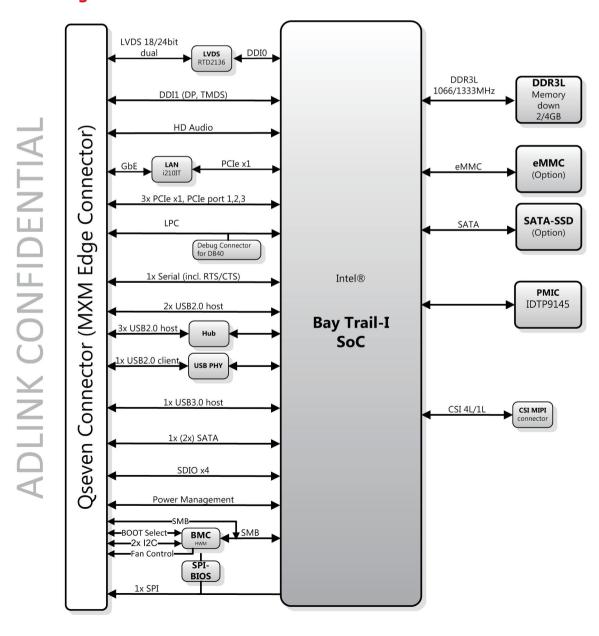
MIL-STD-202F, Method 213B, Table 213-I, Condition A and Method 214A, Table 214-I,

Condition D

HALT Thermal Stress, Vibration Stress, Thermal Shock

and Combined Test

Functional Diagram



SEMA®:

- Local management, control of embedded computer systems
- Extended EAPI for monitoring, controlling and analytics applications
- Multiple OS support and across platforms (x86, ARM)

Ordering Information

• Q7-BT4-4G-8G-ER

Qseven module with Intel® Atom E3845, quad core, 4 GB DDR3L, 8GB eMMC, -40°C to +85°C

• Q7-BT2-4G-8G-ER

Qseven module with Intel® Atom E3826, dual core, 4 GB DDR3L, 8GB eMMC, -40°C to +85°C

• Q7-BT4-4G-8GS-ER

Qseven module with Intel® Atom E3845, quad core, 4 GB DDR3L, 8GB SATA SSD, -40°C to +85°C

• Q7-BT1-2G-8G-ER

Qseven module with Intel® Atom E3815, single core, 2 GB DDR3L, 8GB eMMC, -40°C to +85°C

Q7-BT-HS

Heatspreader for Q7-BT

Q7-BT-HS2

Passive heatsink for Q7-BT, dual core, 0°C to 70°C

*other configurations by request

SEMA Cloud®:

- Application ready comprehensive industrial grade IoT Platform
- Connecting Devices to a Cloud Platform and to Web Applications
- Remote monitoring and controlling managing of connected devices
- Enabling integration of operational device data into business processes
- Cloud based Platform as a Service (PaaS)

